**Vishay Siliconix** 

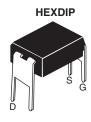
RoH

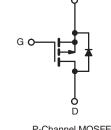
COMPLIANT



## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	- 100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.60		
Q <sub>g</sub> (Max.) (nC)	18			
Q <sub>gs</sub> (nC)	3.0			
Q <sub>gd</sub> (nC)	9.0			
Configuration	Single			





P-Channel MOSFET

#### **FEATURES**

- · Dynamic dV/dt Rating
- · Repetitive Avalanche Rated
- · For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- · Fast Switching
- Lead (Pb)-free Available

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HEXDIP
Lead (Pb)-free	IRFD9120PbF
	SiHFD9120-E3
SnPb	IRFD9120
	SiHFD9120

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25 ^{\circ}C$ , unless otherwise noted						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V <sub>DS</sub>	- 100	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
Continuous Drain Current	$T_{\rm C} = 25 ^{\circ}{\rm C}$	1	- 1.0			
	$V_{GS} \text{ at - 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	I <sub>D</sub>	- 0.70	А		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	- 8.0				
Linear Derating Factor		0.0083	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	140	mJ			
Repetitive Avalanche Current <sup>a</sup>	I <sub>AR</sub>	- 1.0	А			
Repetitive Avalanche Energy <sup>a</sup>	E <sub>AR</sub>	0.13	mJ			
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	PD	1.3	W		
Peak Diode Recovery dV/dtc	dV/dt	- 5.5	V/ns			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	- °C			
Soldering Recommendations (Peak Temperature)	for 10 s		300 <sup>d</sup>			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 52 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = -2.0 \text{ A}$  (see fig. 12).

c.  $I_{SD} \leq$  - 6.8 A, dI/dt  $\leq$  110 A/µs,  $V_{DD} \leq V_{DS},\,T_J \leq$  175 °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		-					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V$ , $I_D = 250 \mu A$		- 100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	Reference to 25 °C, I <sub>D</sub> = - 1 mA		- 0.10	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
		V <sub>DS</sub> =	V <sub>DS</sub> = - 100 V, V <sub>GS</sub> = 0 V		-	- 100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 80 V	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 0.6 A <sup>b</sup>	-	-	0.60	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = ·	- 50 V, I <sub>D</sub> = - 0.60 A <sup>b</sup>	0.71	-	-	S
Dynamic		·					•
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ $V_{DS} = -25 V$ f = 1.0 MHz, see fig. 5		-	390	-	pF
Output Capacitance	Coss			-	170	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	45	-	
Total Gate Charge	Qg		I <sub>D</sub> = - 6.8 A, V <sub>DS</sub> = - 80 V see fig. 6 and 13 <sup>b</sup>	-	-	18	nC
Gate-Source Charge	$Q_gs$	V <sub>GS</sub> = - 10 V		-	-	3.0	
Gate-Drain Charge	$Q_gd$			-	-	9.0	
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.6	-	
Rise Time	t <sub>r</sub>		- 50 V, I <sub>D</sub> = - 6.8 A	-	29	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{G} = 18 \Omega,$	$V_{DD} = -50 V$ , $T_D = -6.8 A$ $R_G = 18 \Omega$ , $R_D = 7.1 \Omega$ , see fig. 10 <sup>b</sup>		21	-	- ns
Fall Time	t <sub>f</sub>			-	25	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	nH
Drain-Source Body Diode Characteristic	s	·				•	•
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 1.0	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 8.0	
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25 \text{ °C}, I_{S} = -1.0 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	- 6.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 6.8 A, dl/dt = 100 A/µs <sup>b</sup>		-	98	200	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.33	0.66	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and L				Ln)	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

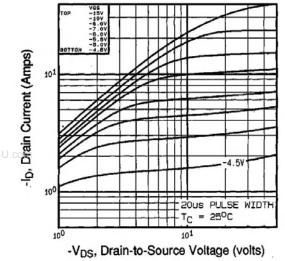


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

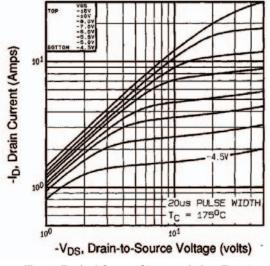
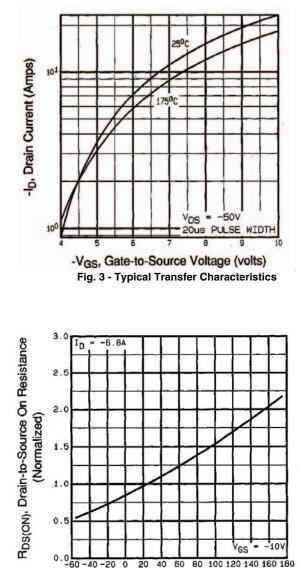


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C



TJ, Junction Temperature (°C) Fig. 4 - Normalized On-Resistance vs. Temperature

0

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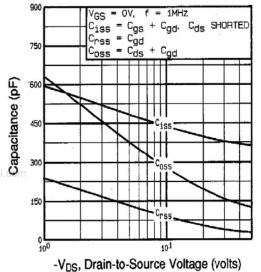


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

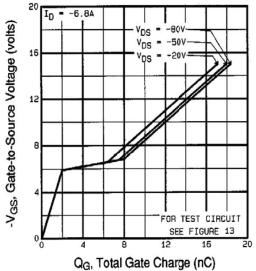
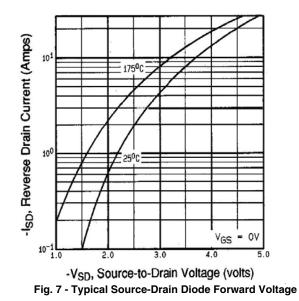
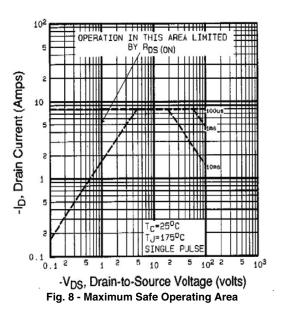


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





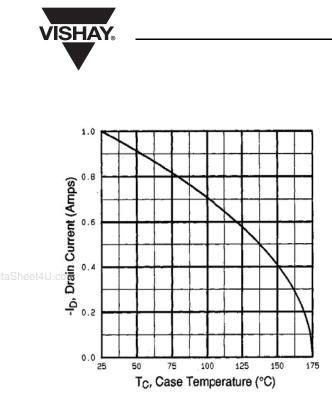


Fig. 9 - Maximum Drain Current vs. Case Temperature

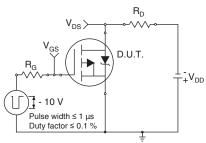


Fig. 10a - Switching Time Test Circuit

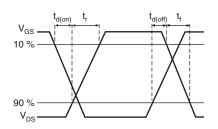


Fig. 10b - Switching Time Waveforms

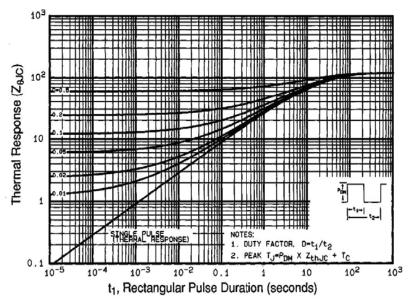


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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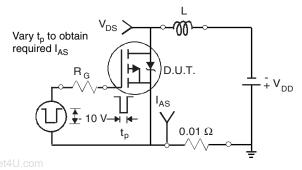


Fig. 12a - Unclamped Inductive Test Circuit

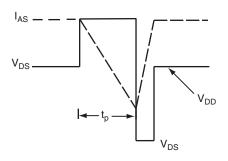
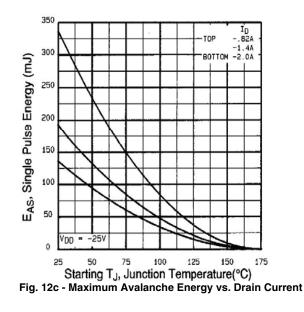
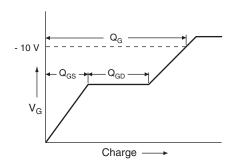


Fig. 12b - Unclamped Inductive Waveforms







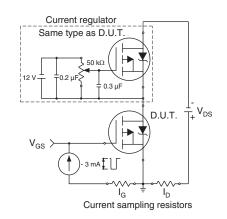
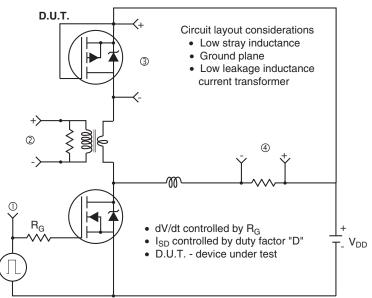


Fig. 13b - Gate Charge Test Circuit



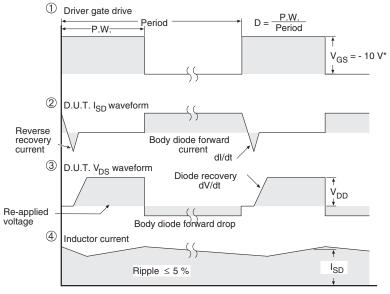
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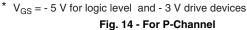




### Peak Diode Recovery dV/dt Test Circuit

• Compliment N-Channel of D.U.T. for driver





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91139.



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